

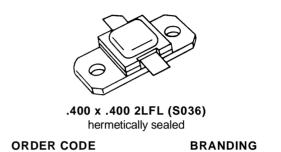
# AM80814-025

PRELIMINARY DATA

# RF & MICROWAVE TRANSISTORS L-BAND RADAR APPLICATIONS

## REFRACTORY/GOLD METALLIZATION

- EMITTER SITE BALLASTED
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- $P_{OUT} = 25$  W MIN. WITH 7.0 dB GAIN



AM80814-025

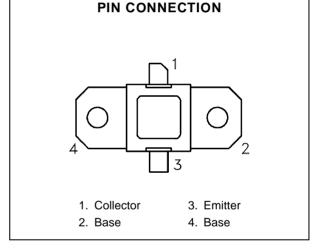
80814-25

#### DESCRIPTION

AM80814-025 is a high power silicon Class C transistor designed for ultra-broadband L-Band radar applications.

This device is capable of operation over a broad range of pulse widths and duty cycles. Low RF thermal resistance and computerized automatic wire bonding techniques ensure high reliability and product consistency.

AM80814-025 is supplied in the industry-standard AMPAC<sup>™</sup> hermetic Metal/Ceramic package incorporating Input/Output impedance matching.



ABSOLUTE MAXIMUM RATINGS	$(T_{case} = 25^{\circ}C)$
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Symbol	Parameter	Value	Unit
P <sub>DISS</sub>	Power Dissipation*( $T_C \le 75^{\circ}C$ )	75	W
Ι <sub>C</sub>	Device Current*	3.5	А
V <sub>CC</sub>	Collector-Supply Voltage*	38	V
TJ	Junction Temperature (Pulsed RF Operation)	250	°C
T <sub>STG</sub>	Storage Temperature	– 65 to +200	°C

# THERMAL DATA

RTH(j-c)Junction-Case Thermal Resistance*2.3°C/W
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\*Applies only to rated RF amplifier operation

# AM80814-025

# **ELECTRICAL SPECIFICATIONS** ( $T_{case} = 25^{\circ}C$ )

# STATIC

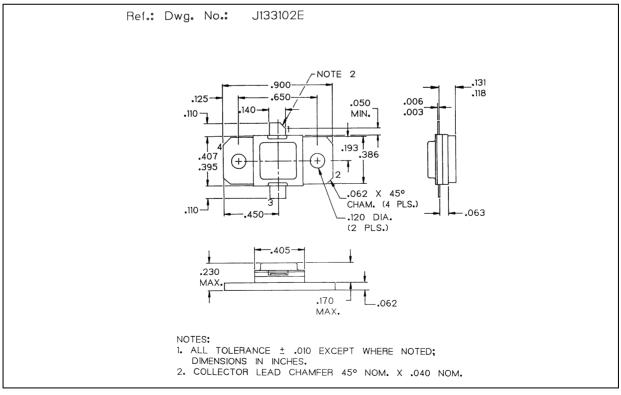
			Value			
Symbol		Test Conditions	Min.	Тур.	Max.	Unit
ВУсво	$I_C = 10 mA$	$I_E = 0mA$	55	—	—	V
BVEBO	$I_E = 1 m A$	$I_{C} = 0 m A$	3.5	—		V
BVCER	IC = 20mA	$R_{BE} = 10\Omega$	55	_		V
ICES	$V_{\text{BE}} = 0V$	$V_{CE} = 28V$	—	_	5	mA
h <sub>FE</sub>	$V_{CE} = 5V$	$I_{C} = 1A$	15	_	150	_

#### DYNAMIC

					Value		
Symbol		Test Conditions	5	Min.	Тур.	Max.	Unit
Pout	f = 850 — 1400MHz	$P_{\text{IN}}=5.0W$	$V_{CC} = 35V$	25	—		W
ηc	f = 850 — 1400MHz	$P_{\text{IN}}=5.0W$	$V_{CC} = 35V$	38	—		%
GP	f = 850 — 1400MHz	$P_{\text{IN}}=5.0W$	$V_{CC}=35V$	7.0			dB

Note: Pulse Width =  $120\mu$ S Duty Cycle = 4%

# PACKAGE MECHANICAL DATA



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